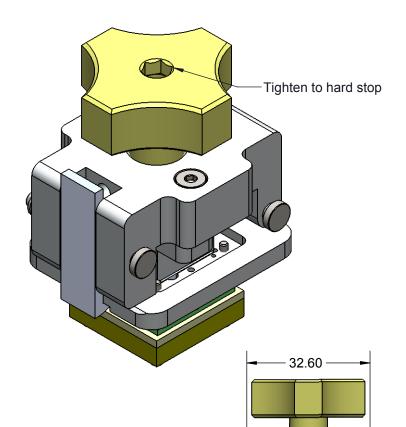
CBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR BURN-IN AND TEST APPLICATIONS

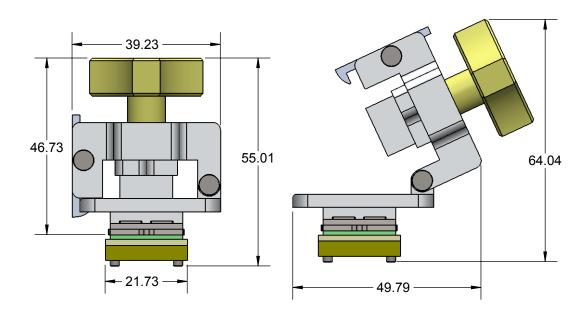


Features

- Wide temperature range (-55C to +180C)

- High current capability (up to 4A)

 Excellent signal integrity at high frequencies
 Low and stable contact resistance for reliable production vield
- Highly compliant to accommodate wide co-planarity
- Automated probe manufacturing enables low cost and short lead time



Description: Socket

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

6.13

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

7.11

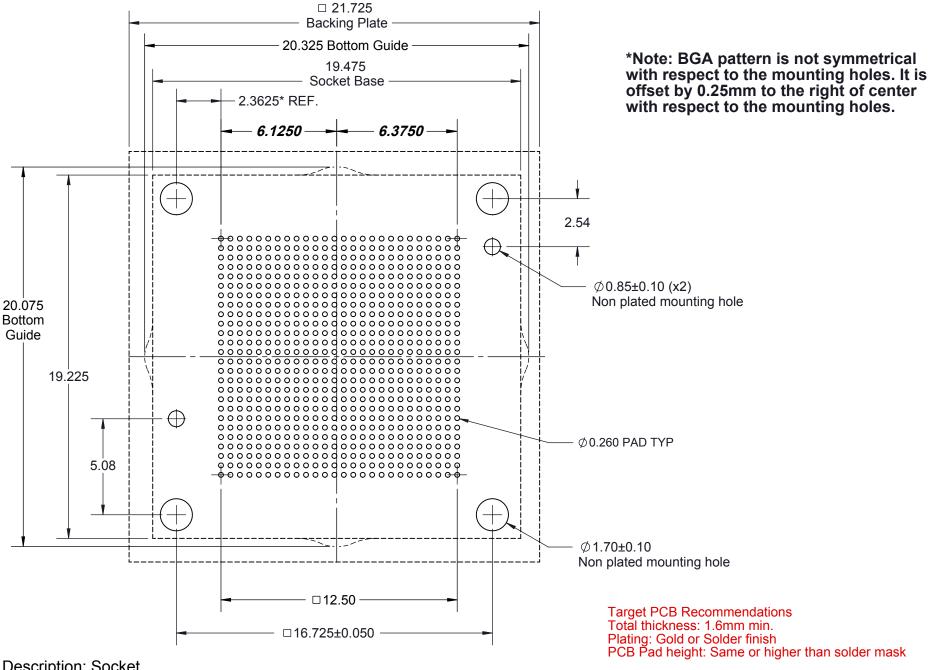
CBT-BGA-7009 Drawing
@201E Ironwood Floatronia

5 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com

Material: Material <not specified> Finish: n/a Weight: 85.19

4.73

STATUS: Released	SHEET: 1 OF 5	REV. B
ENG: M. A. Fedde	DRAWN BY: M. Raske	SCALE: 1:1
FILE: CBT-BGA-7009	DATE: 8/22/2012	



Description: Socket

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

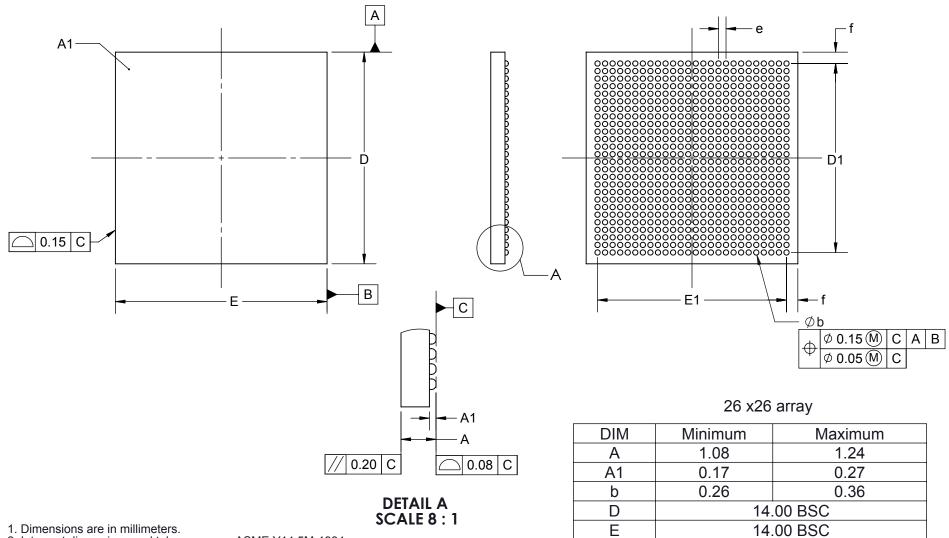
CBT-BGA-7009 Drawing

©2015 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com

Material: Material <not specified> Finish: n/a Weight: 85.19

STATUS: Released	SHEET: 2 OF 5	REV. B
ENG: M. A. Fedde	DRAWN BY: M. Raske	SCALE: 5:1
FILE: CBT-BGA-7009	DATE: 8/22/2012	

Ironwood Package Code: BGA676E2



- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 3. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane C.
- 4. Datum C (seating plane) is defined by the spherical crowns of the solder balls.
- 5. Parallelism measurement shall exclude any effect of mark on top surface of package.

Description: Socket

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-BGA-7009 Drawing		Material: Material <not specified=""></not>	STATUS: Released	SHEET: 3 OF 5	REV. B
	©2015 Ironwood Electronics, Inc. Tele: (800) 404-0204	Finish: n/a Weight: 85.19	ENG: M. A. Fedde	DRAWN BY: M. Raske	SCALE: 4:1
	www.ironwoodelectronics.com		FILE: CBT-BGA-7009	DATE: 8/22/2012	

D1

E1

е

f

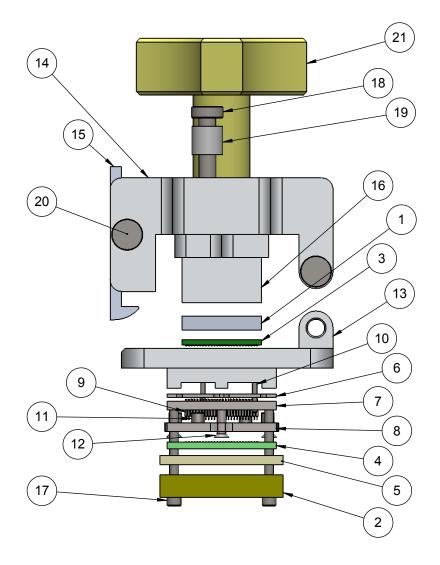
12.50 BSC

12.50 BSC

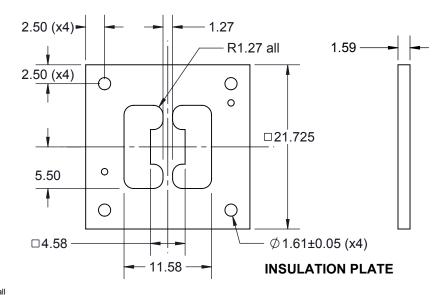
0.50 BSC

0.825

0.675



ITEM NO.	DESCRIPTION	Material
1	Compression Plate, 13.95 X 13.95	7075-T6 Aluminum Alloy
2	SBT/CBT Ni plt Backing Plate, 14mm	7075-T6 Aluminum Alloy
3	BGA676 0.5mm pitch 27x27 array 14x14mm	FR4
4	Target PCB BGA676 0.5mm pitch 26x26 array	FR4
5	Insulation Plate	FR4 Standard
6	Floating Guide	PEEK Ceramic filled
7	Middle Pogo Guide	PEEK Ceramic filled
8	Bottom Pogo pin Guide	PEEK Ceramic filled
9	SBT Pin, SBT-BGA 0.5mm-0.8mm	
10	Dowel pin, 1/32" X 1/4", SS	Stainless Steel (18-8)
11	Floating Guide Spring	Alloy Steel (SS)
12	#0-80, 90 deg., head pin guide screw, Peek material 5.5715mm overall Length	PEEK unfilled
13	Socket Base	7075-T6 Aluminum Alloy
14	Clam Shell	7075-T6 Aluminum Alloy
15	Latch 10-17mm clamshell	7075-T6 Aluminum Alloy
16	Compression Plate	7075-T6 Aluminum Alloy
17	#0-80 X .625 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE	Alloy Steel
18	Screw, M3 x 12mm, Low Head Cap, SS	18-8 Stainless Steel
19	Spring Clamshell lid assembly	Steel Music Wire
20	Hinge Pin and Snap Ring, 3mm OD, 25mm long, SS	Stainless Steel (ferritic)
21	COMPRESSION SCREW, 17MM X M10	7075-T6 Aluminum Alloy



Description: Socket

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

 $\underline{\textbf{Tolerances:}} \ \ \textbf{Hole diameters \pm 0.03mm [\pm 0.001"], Pitches (from true position) \pm 0.025mm [\pm 0.001"], substrate thickness tolerance \pm 10\%, all other tolerances \pm 0.13mm [\pm 0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.}$

СВ	T-BG	4-7009 I	Orawin
	©2015	Ironwood	Electron

©2015 Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: Material <not specified> Finish: n/a Weight: 85.19

STATUS: Released	SHEET: 4 OF 5	REV. B
ENG: M. A. Fedde	DRAWN BY: M. Raske	SCALE: 3:1
FILE: CBT-BGA-7009	DATE: 8/22/2012	

Rev	Date	Initials	Description
В	3/13/15	RP/MR	Changed spring pin and guides to new design, dowel pin protrusion adjusted if needed, metal screws replaced with plastic screws. Contact Ironwood for details.

Description: Revisions

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CI	BT-BGA-7009 Drawing
A	©2015 Ironwood Electronic Tele: (800) 404-0204

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Material: Finish: Weight:

STATUS: Released	SHEET: 5 OF 5	REV. B
ENG: M. A. Fedde	DRAWN BY: M. Raske	SCALE: 3:1
FILE: CBT-BGA-7009	DATE: 8/22/2012	